

Pennsylvania Society of Professional Engineers
Philadelphia Chapter

P.O. Box 11264
Elkins Park, PA 19027-0264

Scholarship Application Form
2020 / 2021 Scholarship Cycle

PERSONAL INFORMATION

Name: _____

SSN#: _____ Date of Birth: ___/___/___ Telephone: _____

Email address: _____

Permanent Mailing Address: _____

U.S. Citizen: Y/N
City of Philadelphia Resident: Y/N
Did you participate in MATHCOUNTS: Y/N If yes, what years? _____

Name of Local Newspaper/Address/Zip: _____

Specified Scholarships:	Colleges Applied To:
<input type="checkbox"/> Do you wish to apply for the TEMPLE UNIVERSITY scholarship?	_____ / ___ / ___
	_____ / ___ / ___
	_____ / ___ / ___
	_____ / ___ / ___
	_____ / ___ / ___
	_____ / ___ / ___
	Engineering Major Chosen: _____

NOTICE: AWARD OF SPECIFIED SCHOLARSHIPS ARE CONTINGENT UPON ACCEPTANCE OF APPLICANT BY NAMED SCHOOL AND ACTUAL ENROLLMENT IN **ENGINEERING** PROGRAM AT NAMED SCHOOL.

TEST SCORES

Each applicant must meet both of the minimum requirements for one of the following tests. Below, post test scores from your transcript or other enclosed documentation. Do not mix scores from different dates.

TEST NAME	SAT Math	SAT Verbal	ACT Math	ACT English	PAA Quant	PAA Verbal
Your Scores						
Date of Test						
Minimum Scores	600	500	29	25	750	640

For the 2019-2020 school year, the scholarship committee will be tracking the SAT Writing score, but will not include such in rating applicants. If you have taken the SAT, please provide your Writing Score here: _____

APPLICANT'S CERTIFICATION AND PERMISSION TO RELEASE INFORMATION

I hereby certify that all information submitted on this application is true and accurate to the best of my knowledge. I understand that submitting non-factual information will automatically disqualify me from any consideration for a scholarship. By Submitting this application, I authorize my high school principal or counselor to make available to the Pennsylvania Society of Professional Engineers ('PSPE') and its Philadelphia Chapter information concerning my academic records.

OPTIONAL: I hereby grant permission to allow PSPE to release information contained herein to other potential sources of scholarship assistance for engineering studies. [] YES [] NO

Applicant's signature: _____ Date: ___ / ___ / ___

COUNSELOR'S OR PRINCIPAL'S CERTIFICATION

I hereby certify that the academic information and summary of school activities as submitted on this application are correct, that to the best of my knowledge applications have been submitted by the applicant to the schools listed and the applicant meets all eligibility requirements as outlined here.

Signature: _____ Date: ___ / ___ / ___

Printed Name: _____

High School: _____

Address: _____ City: State: Zip: _____

Email: _____ Telephone #: _____

RETURN APPLICATION TO:

FREDRIC L. PLOTNICK, ESQ., P.E.
P. O. BOX 11264
ELKINS PARK, PA 19027-0264

DO NOT MAIL THIS APPLICATION TO PSPE HEADQUARTERS OR PSPE CHAPTER'S POST BOX.

APPLICATION DEADLINE -- Applications must be POSTMARKED by January 22, 2021